

TIE INTERVIEW PRESENTATION

Keegan May

Mechatronics Engineering

Texas A&M University

Graduate Student / Intern Candidate

Specializing in Semiconductor Manufacturing, Robotics & Automation

PREPARED FOR DR. SHANKAR DEVASENATHIPATHY

Director, Failure Analysis & Characterization



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Fort Worth, TX

About Me



EDUCATION



Texas A&M University

B.S. Mechatronics Engineering

May 2026

MINOR



Embedded Systems Programming

🚀 Focus Areas & Passion

- **Semiconductor Manufacturing**

Driving innovation in advanced packaging and process integration.

- **Robotics & Automation**

Applying automated systems to enhance manufacturing scalability.

undlerstanding

Hands-on Fab Experience: Practical knowledge of CVD, Etch, and Metrology tools.

Process Optimization: Data-driven mindset for improving throughput and yield.

Cross-functional Teamwork: Proven leadership in large engineering organizations.

Why TIE?

The graphic features a large grey target icon on the right. To its left is a blue circular icon containing a white network or 'TIE' symbol. Below these are three sections of text: 'TARGET IMPACT' with a small icon above it, 'Accelerating Innovation' in large bold letters, and a descriptive paragraph about combining mechatronics and semiconductor packaging expertise. At the bottom are three rounded rectangular buttons labeled 'Failure Analysis', 'Characterization', and 'Process Integration'.

TARGET IMPACT

Accelerating Innovation

Combining mechatronics expertise with advanced semiconductor packaging to support TIE's mission.

Failure Analysis Characterization

Process Integration

👤 Alignment with Dr. Devasenathipathy

- Through Silicon Vias (TSVs): Strong interest and experience in working on innovative manufacturing processes.
- Optical Diagnostics: Prior research in spectroscopic reflectometry aligns with expertise in optical diagnostics.
- Molecular Pharmacology: Understanding of microfluidics of particles in biological system used in drug-delivery systems.

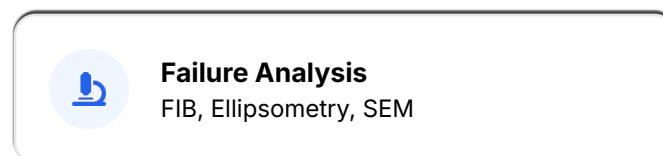
📅 Mission & Contribution

- Ecosystem Growth: Excited to innovate traditional semiconductor landscape by exploring new manufacturing processes.
- Automation Mindset: Applying robotics principles to create repeatable, high-quality failure analysis workflows.

PROFESSIONAL EXPERIENCE

Semiconductor Manufacturing

Core Competencies



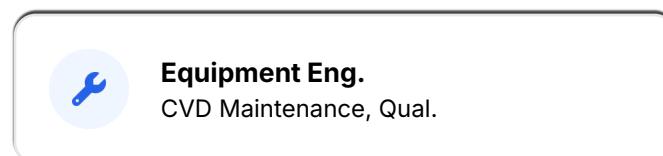
Failure Analysis

FIB, Ellipsometry, SEM



Process Integration

Yield Improvement, TFF



Equipment Eng.

CVD Maintenance, Qual.

- Process Engineer** FEB 2025 – PRESENT
BrYet Pharmaceuticals | Houston, TX
Developing injectable silicon nanoparticles using semiconductor manufacturing techniques.
Analyzing nanopores on micro-pillar array wafers using Focused-Ion-Beam (FIB) microscopy; providing defect feedback to GlobalFoundries.
Introduced nanoparticle tangential flow filtration (TFF) process, significantly reducing lead time.
- Process Engineer (Biomedical Devices)** SUMMER 2024
Medtronic | Tempe, AZ
Qualified automated semiconductor tools for micro-scale device manufacturing.
Optimized throughput by 4.1% and improved tool capacity by 33% in photoresist strip/etch processes.
Developed non-destructive inspection using spectroscopic ellipsometry to detect contamination.
- Equipment Engineering Technician** SUMMER 2022
Samsung Austin Semiconductors | Austin, TX
Performed tool maintenance and troubleshooting on Chemical Vapor Deposition (CVD) equipment.
Designed digital SOP templates with CAD models to streamline maintenance documentation.

ACADEMIC BACKGROUND

Research Experience



Soft Robotics
Mechanics & FEA



Nanofabrication
Thin Films & Metrology



Process Optimization
Experimental Analysis



Technical Leadership
Training & Safety

MULTIDISCIPLINARY FOCUS

Research Assistant **SOFT ROBOTICS**

Texas A&M Dept. of Multidisciplinary Engineering

FEA & CAD

PID Control

- Designed CAD models and conducted Finite Element Analysis (FEA) to guide design adjustments for parts with variable mechanical properties.
- Implemented PID tuning for IMU sensors to provide robust feedback on real-time 3D kinematics.

Undergraduate Researcher **NANOFABRICATION**

30+ Trained

RIE Process

AggieFab Nanofabrication Facility

- Performed experimental analysis optimizing etch rate and uniformity of reactive-ion etch (RIE) processes.
- Performed process monitors on etch and metrology equipment ensuring stable baseline performance.
- Developed thin-film models for SiN, Si₃N₄, and SiO₂.
- Trained 30+ researchers on semiconductor equipment.

Research Assistant **ADDITIVE MANUFACTURING**

Texas A&M Industrial & Systems Engineering

Binder Jetting

Composites

- Developing metal composites using binder jet technology to innovate manufacturing capabilities.

- Analyzing mechanical performance and material properties to characterize composite structural integrity.

LEADERSHIP EXPERIENCE

Robotics & Automation



CAPTAIN & LEAD

1st Place North America Championship



Texas A&M Robomasters

Robotics Team Captain

- Led 140+ engineering students across electrical, mechanical, and programming sub-teams.
- Directed design and fabrication of complex robots for international competitions, ensuring system reliability.
- Hosted STEM outreach events and conferences with local K-12 schools to inspire future engineers.

KEY ACHIEVEMENT

🥇 North America Champions



Texas Combat Robotics

EVENT COORDINATOR, JUDGE, INSPECTOR

- Coordinated TAMU's largest robotics event featuring BattleBots teams (Riptide, SubZero).
- Organized critical safety inspections, judging protocols, and live broadcasting operations.



Leadership Competencies



System Integration



Project Management



Technical Mentorship



Safety Protocols

Robotics & Automation Projects

Engineering solutions integrating embedded systems, computer vision, and mechanical design.



Teleoperated Robot Hand

ESP32 Flex Sensors C++

Designed a remotely operated robotic hand controlled by a sensory glove. Implemented sensor fusion algorithms to map human finger flexure to servo actuation for precise, real-time mimicry.

⚙️ Embedded Systems



Smart Drone Landing Pad

LiDAR Computer Vision Raspberry Pi

Engineered an autonomous landing system with active bed-leveling. Integrated LiDAR for obstacle avoidance and computer vision algorithms for precise color tracking and target alignment.

⌚ Machine Vision



Autonomous Sentry Robot

Mechanical Design Control Systems

Built a mobile robot featuring a custom suspension drivetrain and a double-flywheel turret. Developed navigation logic for autonomous pathing and object targeting systems for competitive utility.

⚙️ Mechatronics

+ Additional Project: Robotic Snake utilizing lateral undulation gait with motion tracking and MATLAB feedback control.

</> MATLAB

Technical Skills Overview

Comprehensive toolkit for
Engineering & Manufacturing



Manufacturing & Fabrication

Semiconductor Manufacturing

CNC Mill & Lathe

Additive Manufacturing

Laser Cutter

3D Printing



Programming & Control

Python

C / C++

Java

ROS2

Assembly

HTML/CSS/JS



CAD & Mechanical Design

SolidWorks

Autodesk Fusion 360

OnShape

Autodesk Inventor



Certifications & Analysis

Lean Six Sigma Green Belt

Chemical Safety

Google Data Analytics

Microsoft Excel

Harvard CS50

Relevant Expertise



CORE DOMAIN

Semiconductor Engineering

Bridging process reliability with automation efficiency.



KEY TECHNOLOGIES

- CVD & Etch
- Metrology
- FIB Analysis
- Robotics

Process Engineering & Equipment

Experience qualifying and maintaining tools for Chemical Vapor Deposition (CVD), Etch, and Deposition processes.

- ✓ Proven ability to develop reusable digital SOP templates with embedded CAD models for maintenance efficiency.

Failure Analysis & Characterization

Hands-on expertise with FIB (Focused Ion Beam), spectroscopic ellipsometry, and reflectometry for defect detection.

- ✓ Skilled in establishing defect inspection processes to reduce film non-uniformity and improve process yield.

Automation Mindset & Leadership

Standardized procedures and trained 30+ researchers on critical metrology and fabrication equipment.

- ✓ Optimization-focused approach: Demonstrated capacity improvements (+33%) through data-driven workflow adjustments.

What I Bring to TIE

Aligning robotics precision with advanced semiconductor packaging.

Semiconductor Processing

Aligned with optical diagnostics (FIB, Ellipsometry) for failure analysis objectives. Deep interest in innovative manufacturing process.

Multidisciplinary Experiences

Experience working on robotics and automation projects in cross-functional environments. Knowledge about material science, mechanical design, electronics, programming, machine learning and AI.

TAILORED CONTRIBUTION FOR

Dr. Devasenathipathy's Team

Measurable Impact

+4.1%

FACILITY THROUGHPUT

Optimized photoresist strip processes at Medtronic

+33%

TOOL CAPACITY

Improved dry etch efficiency via process qualification

140+

Engineering Students Led

Captain of Robomasters; complex systems integration

30+

Researchers Trained

AggieFab Nanofabrication Facility equipment training

Operational Excellence Core Competencies



Process Characterization

Thin-film models (SiN, SiO₂)



Equipment Maintenance

CVD troubleshooting & SOPs



Technical Communication

Authored qualification reports



Automation Integration

Robotics applied to manufacturing

Thank You

I appreciate the opportunity to discuss how my background in semiconductor manufacturing and automation can contribute to TIE's mission.

[Q&A Session](#)

[Next Steps](#)

Keegan May

Mechatronics Engineering Candidate

"Passionate about advancing semiconductor manufacturing through robotics and automation."



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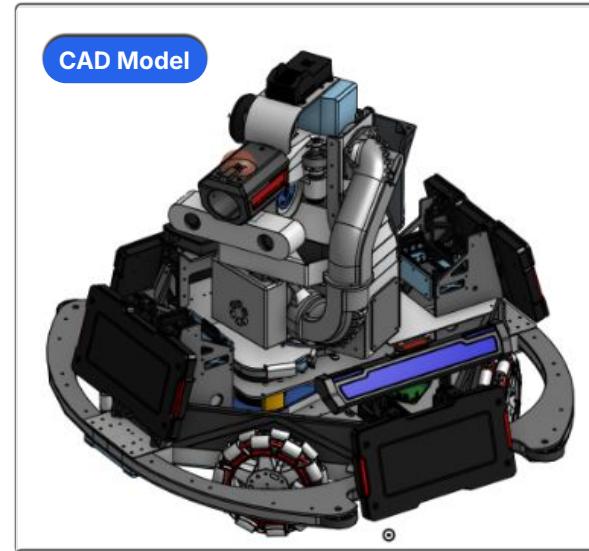
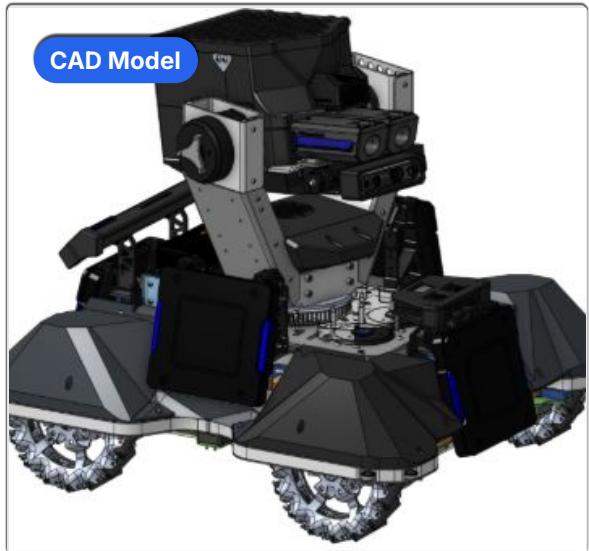


LOCATION

Fort Worth, Texas

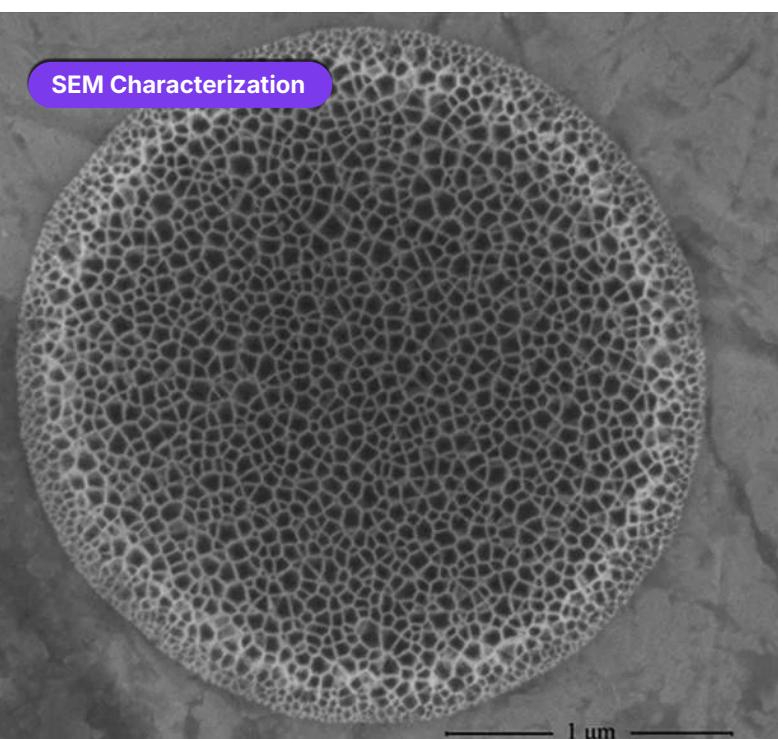
Robotics Engineering Portfolio

CAD Design • Fabrication • Systems Integration

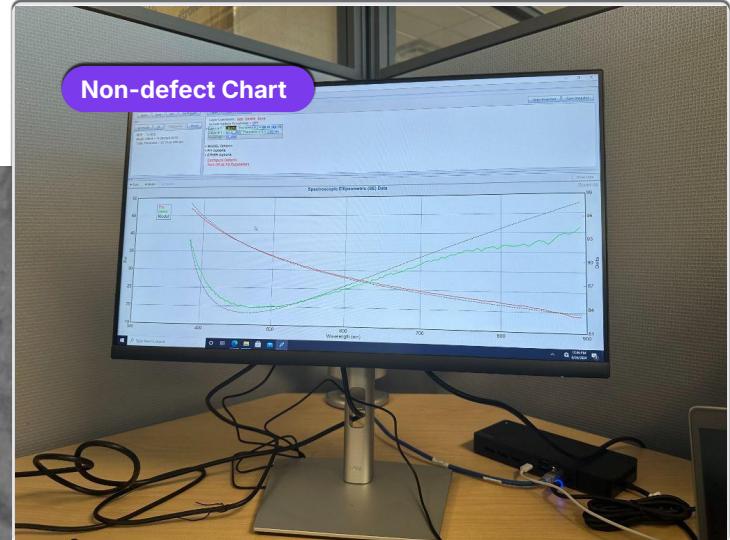


Metrology & Process Monitoring

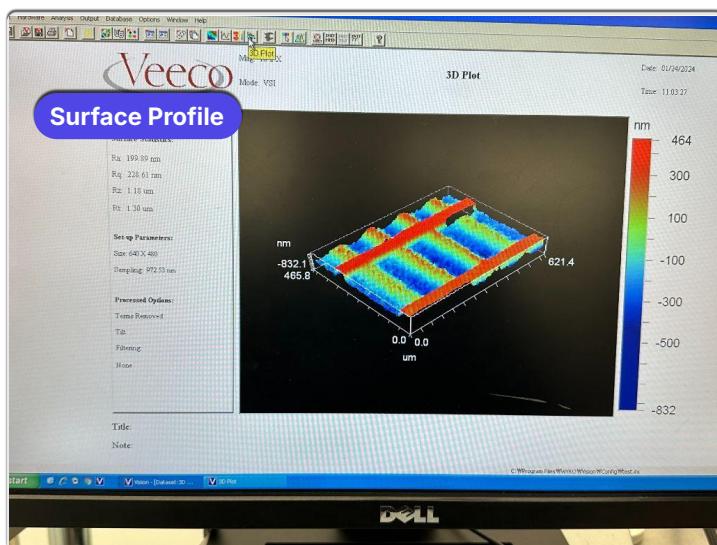
Optical Diagnostics • FIB Analysis • Process Control



SEM Characterization



Non-defect Chart



Defect Chart

Professional Gallery

Cleanroom Protocols • Team Leadership • Research

